

AMENDMENTS TO THE CLAIMS, COMPLETE LISTING OF CLAIMS
IN ASCENDING ORDER WITH STATUS INDICATOR

Please amend and add the following claims as indicated.

Claims 1-7 (Canceled).

8. (Currently Amended) ~~The A curable resin composition according to claim 6~~
comprising a curing component containing an amino group-containing compound (A), a ketone
compound (B), a ketimine compound (C), and water (D) as a curing agent, wherein the amino
group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the
water (D) are in equilibrium or in stable coexistence by a equilibrium relationship and wherein a
prepolymer of a main part of the curable resin composition is an epoxy resin.

9. (Currently Amended) ~~The A curable resin composition according to claim 6~~
comprising a curing component containing an amino group-containing compound (A), a ketone
compound (B), a ketimine compound (C), and water (D) as a curing agent, wherein the amino
group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the
water (D) are in equilibrium or in stable coexistence by a equilibrium relationship and wherein
prepolymers of a main part of the curable resin composition are a urethane prepolymer and an
epoxy resin.

10. (Canceled).

11. (Currently Amended) The curable resin composition according to claim 8, wherein
the main part of the curable resin composition ~~of claim 8~~ contains a prepolymer other than the
epoxy resin.

12. (Currently Amended) The curable resin composition according to claim 9, wherein the main part of the curable resin composition ~~of claim 9~~ contains a prepolymer other than the urethane prepolymer and the epoxy resin.

13. (Canceled).

14. (Currently Amended) The curable resin composition according to claim 9, wherein an isocyanate group at an end of the urethane prepolymer is bonded to a secondary or tertiary carbon atom.

15. (Canceled).

16. (Currently Amended) The curable resin composition according to claim 12, wherein an isocyanate group at an end of the urethane prepolymer is bonded to a secondary or tertiary carbon atom.

17. (New) The curable resin composition according to claim 8, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D) in said curing component is realized by mixing the amino group-containing compound (A) and the ketone compound (B).

18. (New) The curable resin composition according to claim 9, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D) in said curing component is realized by mixing the amino group-containing compound (A) and the ketone compound (B).

19. (New) The curable resin composition according to claim 8, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound

(C), and the water (D) in said curing component is realized by mixing the ketimine compound (C) and the water (D).

20. (New) The curable resin composition according to claim 9, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D) in said curing component is realized by mixing the ketimine compound (C) and the water (D).

21. (New) The curable resin composition according to claim 8, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D) in said curing component is realized by mixing at least three member selected from the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D).

22. (New) The curable resin composition according to claim 9, wherein the coexistence of the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D) in said curing component is realized by mixing at least three member selected from the amino group-containing compound (A), the ketone compound (B), the ketimine compound (C), and the water (D).

23. (New) The curable resin composition according to claim 8, wherein a molar ratio ($C=N/NH_2$) of functional groups between total ketimine groups ($C=N$) to total amino groups (NH_2) in the curing component is in the range of 90/10 to 3/97.

24. (New) The curable resin composition according to claim 9, wherein a molar ratio ($C=N/NH_2$) of functional groups between total ketimine groups ($C=N$) to total amino groups (NH_2) in the curing component is in the range of 90/10 to 3/97.